

APPROVAL SHEET

WR18X(W), WR20X(W), WR25X(W)

±1%, ±5%

Thick Film Power Chip Resistors
Size 1218,2010,2512
RoHS 2 Compliant with exemption 7C-1
Halogen free



FEATURE

- 1. High power rating and compact size
- 2. High reliability and stability
- 3. Reduced size of final equipment
- 4. RoHS 2 compliant with exemption 7C-1 and Halogen free products
- 5. Flammability against UL94-V0

APPLICATION

- Power supply
- PDA
- Digital meter
- Computer
- Automotives
- Battery charger
- DC-DC power converter

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is Tin (lead free) alloy.

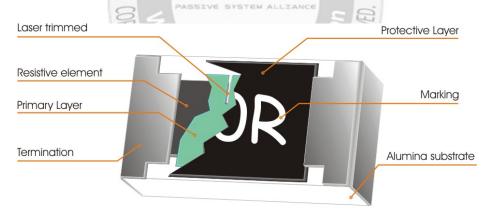


Fig 1. Construction of 2512, 2010 Chip-R

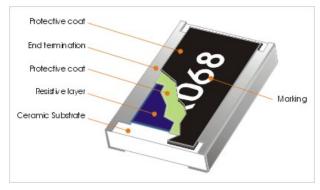


Fig 2. Construction of a 1218 Chip-R

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QUICK REFERENCE DATA

Item	General Specification				
Series No.	WR18X(W)	WR20X(W)	WR25X(W)		
Size code	1218(3248)	2010 (5025),	2512(6432)		
Resistance Tolerance	±5	±5% (E24); ±1% (E24+E96)			
Resistance Range	1Ω ~ 10M Ω , Jumper (0 Ω)				
TCR (ppm/°C): 10Ω < Rn $\leq 10M\Omega$	± 100 ppm/°C	± 100 ppm/°C	± 100 ppm/°C		
1Ω≤ Rn ≤ 10Ω	± 200 ppm/°C	± 200 ppm/°C	± 200 ppm/°C		
Max. dissipation at T _{amb} =70°C	1W	0.75 W	1W		
Max. Operation Voltage (DC or RMS)	(DC or RMS) 200V 200V 250V		250V		
Max. Overload Voltage (DC or RMS)	400V	400V	500V		
Operation temperature	-55 ∼ +155'C				
Storage temperature	5 ~ 40°C				

OF IS

Test conditions for jumper (0 ohm)

			1
Туре	WR18X(W)	WR20X(W)	WR25X(W)
Power Rating At 70C	1 W	3/4 W	1 W
Resistance	Max. 50mR	Max. 50mR	Max. 50mR
Rated Current	4.5 A	3.8 A	4.5 A
Peak Current	11 A	9 A	11 A
Operating Temperature	-55C ~ 155C	-55C ~ 155C	-55C ~ 155C

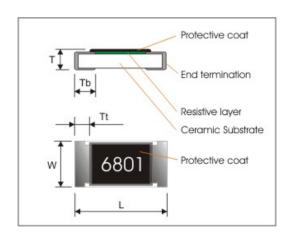
Note:

- 1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2. Max. Operation Voltage: So called RCWV (Rated Continuous Working Voltage) is determined by

 $RCWV = \sqrt{Rated \, Power \times Resistance \, Value} \quad \text{or Max. RCWV listed above, whichever is lower.}$

MECHANICAL DATA (unit: mm)

TYPE	WR18	WR20	WR25
L	3.05±0.15	5.00±0.20	6.40±0.20
W	4.60±0.20	2.50±0.20	3.20±0.20
Т	0.55±0.10	0.55±0.10	0.60±0.10
Tt	0.45±0.25	0.65±0.25	0.65±0.25
Tb	0.50±0.25	0.60±0.25	0.90±0.25





MARKING

Each resistor is marked with a four-digit code on the protective coating to designate the nominal resistance value.

Example:

 $1R00 = 1\Omega$ $1001 = 1000\Omega$ $0000 = 0\Omega$

FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E96 & E24 series for resistors with a tolerance of $\pm 5\%$ & $\pm 1\%$. The values of the E24/E96 series are in accordance with "IEC publication 60063".

Derating curve

The power that the resistor can dissipate depends on the operating temperature; see Fig.3

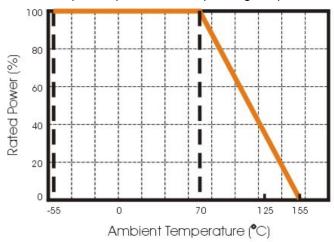


Figure 3. Maximum dissipation in percentage of rated power as a function of the ambient temperature.

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.



SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in below.

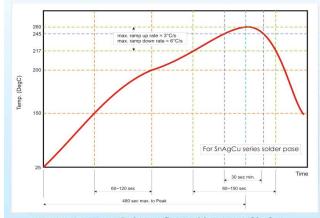


Fig. 1 Recommended IR reflow soldering profile for SMT process with SnAqCu series solder paste.

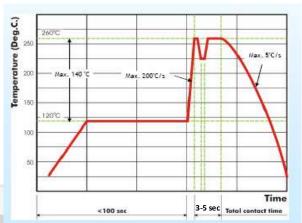


Fig. 2 Recommended wave soldering profile for SMT process with SnAgCu series solder.

CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

WR20	х	472_	J	Т	L
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination code
WR25 : 2512	X:	5% E24 : 2 significant digits	J : ±5%	T: 7" Reel taping	L = Sn base (lead
WR20 : 2010	±5%: 1Ω-10ΜΩ	followed by no. of zeros and a blank	F : ±1%	(T:1218 10" Reel)	free)
WR18: 1218	±1%: 10Ω-1ΜΩ	4.7Ω =4R7_	P : Jumper	Q : 10" Reel taping	
	W :	10Ω =100_()()()()()()()()()()()()()()()()()()(SALIOIA	G: 13" Reel taping	
	1% : <10 Ω or	("_" means a blank)			
	>1MΩ	1% E24+E96: 3 significant digits followed by no. of zeros			
		102Ω =1020			
		37.4KΩ =3742			

TEST AND REQUIREMENTS(JIS C 5201-1: 1998)

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category **LCT/UCT/56** (rated temperature range: Lower Category Temperature, **U**pper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied:

Temperature: 15°C to 35°C. Relative humidity: 45% to 75%.

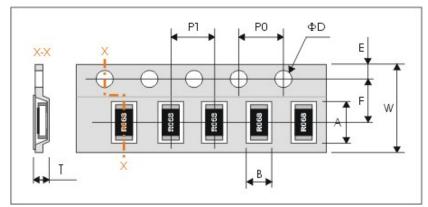
Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar). All soldering tests are performed with midly activated flux.

TEST	PROCEDURE	REQUIREMENT
DC resistance Clause 4.5	DC resistance values measured at the test voltages specified below : <10Ω@0.1V,<100Ω@0.3V, <1ΚΩ@1.0V, <10ΚΩ@3V,	Within the specified tolerance
Temperature Coefficient of Resistance(T.C.R) Clause 4.8	<100KΩ@10V, <1MΩ@25V, <10MΩ@30V Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)} t_1 : 20°C+5°C-1°C$ $R_1 : \text{Resistance at reference temperature}$ $R_2 : \text{Resistance at test temperature}$	Refer to "QUICK REFERENCE DATA"
Short time overload (S.T.O.L) Clause Clause 4.13	Permanent resistance change after a 5second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the above list, whichever is less.	$\pm 5\%$: Δ R/R max. $\pm (2\% + 0.1\Omega)$ $\pm 1\%$: Δ R/R max. $\pm (1\% + 0.05\Omega)$ No visible damage
Resistance to soldering heat(R.S.H) Clause 4.18	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at $260^\circ\!\!\!\!\mathrm{C}\pm\!\!\!5^\circ\!\!\!\;\mathrm{C}$	no visible damage Δ R/R max. $\pm (1\%+0.05\Omega)$
Solderability Clause 4.17	Un-mounted chips completely immersed for 2±0.5 second in a SAC solder bath at 235°C±5°C	good tinning (>95% covered) no visible damage
Temperature cycling Clause 4.19	30 minutes at -55°C±3°C, 2~3 minutes at 20°C+5°C-1°C, 30 minutes at +155°C±3°C, 2~3 minutes at 20°C+5°C-1°C, total 5 continuous cycles	no visible damage $\Delta R/R$ max. $\pm (1\%+0.05\Omega)$
Load life (endurance) Clause 4.25	1000 +48/-0 hours, loaded with RCWV or Vmax in chamber controller 70±2°C, 1.5 hours on and 0.5 hours off	Δ R/R max. \pm (3%+0.1 Ω)
Load life in Humidity Clause 4.24	1000 +48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller at 40°C±2°C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	Δ R/R max. \pm (3%+0.1 Ω)
Bending strength Clause 4.33	Resistors mounted on a 90mm glass epoxy resin PCB(FR4); bending : 2 mm, once for 10 seconds	Δ R/R max. \pm (1%+0.05 Ω)
Adhesion Clause 4.32	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or removal of the terminations
Insulation Resistance Clause 4.6	Apply the maximum overload voltage (DC) for 1minute	R≧10GΩ
Dielectric Withstand Voltage	Apply the maximum overload voltage (AC) for 1 minute	No breakdown or flashover
Clause 4.7		



PACKAGING

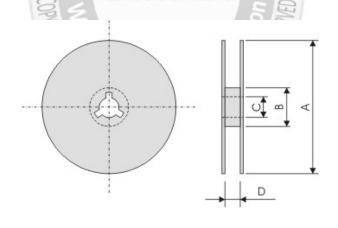
Plastic Tape specifications (unit :mm)



Туре	А	В	W	F	E
WR18	4.90±0.20	3.55±0.30			
WR20	5.50±0.20	2.80±0.20	12.00±0.30	5.50±0.10	1.75±0.10
WR25	6.90±0.20	3.60±0.20	,	,	

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Туре	P1	P0	ΦD	Т
WR18	8.00±0.10	4.00±0.10	Ф1.50 ^{+0.1}	1.30±0.20
WR20	4.00±0.10			MAX1.2
WR25	4.00±0.10			IVIAA 1.2

Reel dimensions



(unit:mm)

Symbol	A	В	С	D
7" Reel	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	12.4.0±1.00
10" Reel	Φ254.0±2.0	Φ100.0±1.0	13.0±0.2	14.0±0.20
13" Reel	Ф330.0±2.0	Φ100.0±1.0	13.0±0.2	14.0±0.20

Taping quantity

WR20, WR25 by plastic tape taping 4,000 pcs per 7" reel; 8,000pcs per 10" reel; 16,000pcs per 13" reel! WR18 by plastic tape taping 3,000 pcs per 10" reel